# Clock OSC SG5032VAN

Product name SG5032VAN 150.000000MHz KCBA
Product Number / Ordering code X1G0042610069xx

Please refer to the 9.Packing information about xx (last 2 digits)

Output waveform LVDS

Pb free / Complies with EU RoHS directive

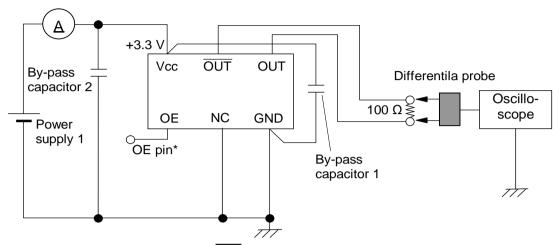
Reference weight Typ. 52 mg

1.Absolute maximum ratings								
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions / Remarks		
Maximum supply voltage	Vcc-GND	-0.3	-	+4	V	-		
Storage temperature	T_stg	-40	-	+125	°C	Storage as single product		
Input voltage	Vin	-0.3	-	Vcc+0.3	V	OE Terminal		

2.Specifications(character				T - 4	1	In	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions / Remarks	
Output frequency	f0	-	150.0000	-	MHz		
Supply voltage	Vcc	2.25	-	3.63	V	-	
Operating temperature	T_use	-20	-	+70	°C	-	
Frequency tolerance	f_tol	-20	-	20	x10 <sup>-6</sup>	-	
Current consumption	Icc	-	•	30	mA	OE = Vcc, L_LVDS = 100 Ω	
Stand-by current	I_std	-	-	-	mA	-	
Disable current	l_dis	-	-	20.0	mA	OE = GND	
Symmetry	SYM	45	-	55	%	At output crossing point	
Output voltage(LVDS)	Vod	250	-	450	mV	-	
	dVop	-	-	50	mV	1-	
	Vos	1.15	-	1.35	V	1-	
	dVos	-	-	150	mV	1-	
Output load condition(LVDS)	L_LVDS	-	100	-	Ω	Connected between OUT and OUT	
Input voltage	V <sub>IH</sub>	70 % Vcc	-	-		-	
-	V <sub>IL</sub>	-	_	30 % Vcc		1-	
Rise time	t <sub>r</sub>	-	-	300	ps	-	
Fall time	tf	-	_	300	ps	-	
Start-up time	t_str	-	_	3	ms	-	
Jitter	t <sub>DJ</sub>	-	5.7	-	ps	Deterministic Jitter Vcc=2.5V	
	T <sub>RJ</sub>	-	1	-	ps	Random Jitter Vcc=2.5V	
	t <sub>RMS</sub>	-	5.1	-	ps	δ(RMS of total distribution) Vcc=2.5V	
	t <sub>p-p</sub>	-	21.4	-	ps	Peak to Peak Vcc=2.5V	
	t <sub>acc</sub>	-	1	-	ps	Accumulated Jitter(δ) n=2 to 50000 cycles Vcc=2.5V	
Phase jitter	t <sub>PJ</sub>	-	0.31	-	ps	Offset Frequency: 12kHz to 20MHz Vcc=2.5V	
Phase noise	L(f)	-	-48	-	dBc/Hz	Offset 1Hz Vcc=2.5V	
		-	-78	-	dBc/Hz	Offset 10Hz Vcc=2.5V	
		_	-105	-	dBc/Hz	Offset 100Hz Vcc=2.5V	
		_	-121	-	dBc/Hz	Offset 1kHz Vcc=2.5V	
		-	-131	-	dBc/Hz	Offset 10kHz Vcc=2.5V	
		-	-137	-	dBc/Hz	Offset 100kHz Vcc=2.5V	
		_	-138	-	dBc/Hz	Offset 1MHz Vcc=2.5V	
Frequency aging	f_age	-5	-	5	x10 <sup>-6</sup> /Year	25 °C, 1st year	
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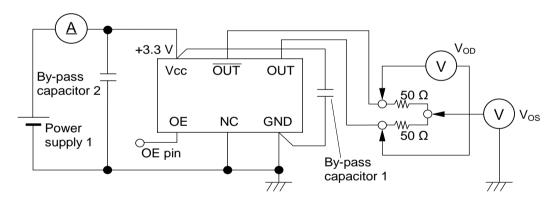
#### 3.Test circuit

1) To observe waveform and current (case 1)



- \* The lines from OUT and OUT pin are same length.
- \* To measure the disable current, OE pin is connected to GND

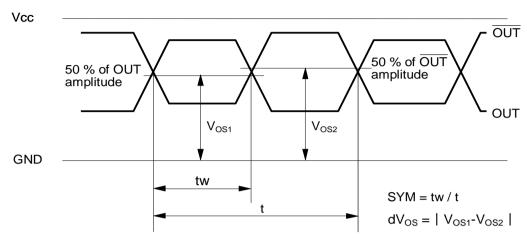
# 2) To observe waveform and current (case 2)



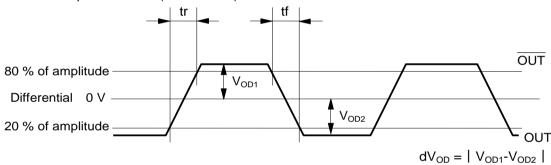
- \* The lines from OUT and OUT pin are same length.
- 3) Measurement condition
- A) Oscilloscope
- •Bandwidth should be 5 times higher than DUT's output frequency (4 GHz).
- •Probe ground should be placed closely from test point and lead length should be as short as possible.
- B) By-pass capacitor 1 (approx. 0.01  $\mu F$  to 0.1  $\mu F$ ) places closely between Vcc and GND.
- C) By-pass capacitor 2 (approx. 10  $\mu F$ ) places closely between power supply terminals on the board.
- D) Use the current meter whose internal impedance value is small.
- E) Power supply
- Start up time (0 Vg90 %Vcc) of power source should be more than 150  $\mu$ s and slew rate should be less than 19.8 mV/ $\mu$ s.
- Impedance of power supply should be as low as possible.

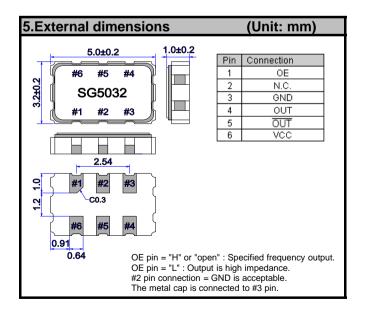
# 4. Timing chart

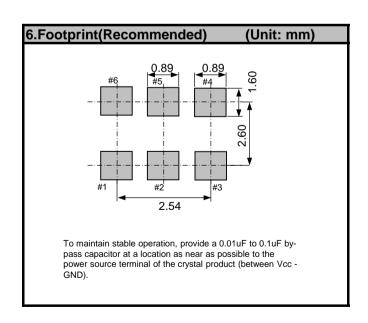
Each output waveform (OUT, and OUT)

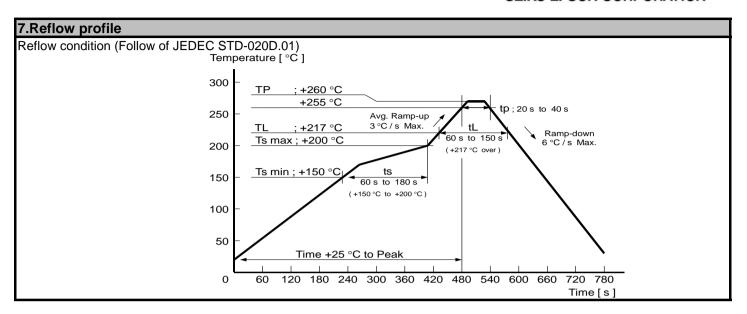


Differential output waveform (OUT - OUT)







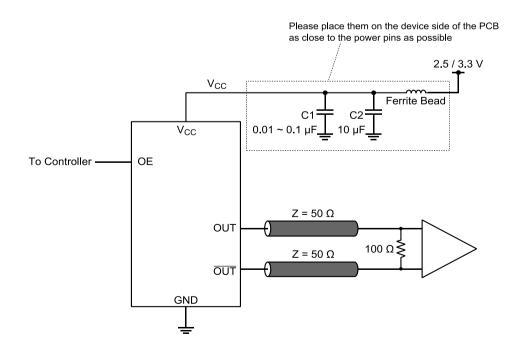


#### 8. Example of schematic layout

This figure shows an example of this product's application schematic.

As with any high speed analog circuitry, the power supply pins for this device are vulnerable to noise. In order to achieve optimum jitter performance, power isolation with filter device is required for power supply pins.

In order to achieve best performance of the power isolation filter, it is recommended that the filter composing devices is placed on the device side of the PCB as close to the power pins as possible. The component value of this filter is just an example, it may have to be adjusted.



- $^*$  By-pass capacitor (approx. 0.01  $\mu F$  to 0.1  $\mu F)$  places closely between Vcc and GND.  $^*$  By-pass capacitor (approx. 10  $\mu F)$  places closely between power supply terminals on the board.  $^*$  Please design the two output lines by characteristic impedance 100  $\Omega$  and same length, and try to make the output lines as short as possible.

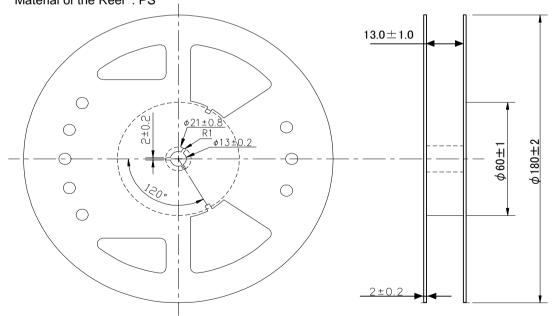
9.Packing	j informa	tion				
[1]Produc	t number la	ast 2 digits code(xx) description	The recommended code is "00"			
	X1G0042	2610069xx				
	Code	Condition	Code	Condition		
	01	Any Q'ty vinyl bag(Tape cut)	13	500pcs / Reel		
	11	Any Q'ty / Reel	00	1000pcs / Reel		
	12	250pcs / Reel				

# **SEIKO EPSON CORPORATION** [ 2 ] Taping specification Subject to EIA-481 & IEC-60286 (1) Tape dimensions Material of the Carrier Tape: PS Material of the Top Tape : PET+PE Unit: mm 0 0 0 0 0 Carrier tape Top tape

I	Symbol	Α	В	С	D	E	F	G	Н
	Value	φ1.5	4.0±0.1	8.0±0.1	7.25±0.2	12.0±0.2	1.40±0.1	3.5±0.1	5.4±0.1
		+0.1/-0							

# (2) Reel dimensions

Center material : PS Material of the Reel: PS



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